



## Product Summary

BV <sub>DSS</sub>	Rds(on) max	I <sub>D мах</sub> @T <sub>A</sub> = +25°С
2017	0.75Ω @ Vgs = -4.5V	-0.63A
-20V	1.05Ω @ V <sub>GS</sub> = -2.5V	-0.54A

## Description

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## **Applications**

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Power Supply Converter Circuits

## Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET Ultra-Small Surface Mount Package
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2) Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts gualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

## **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 @3)
- Terminal Connections: See Diagram

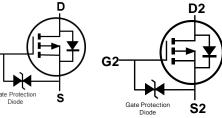
**Q2 P-CHANNEL** 

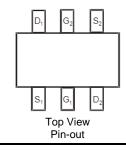
Weight: 0.006 grams (Approximate)





Top View





## Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2900UDW-7	SOT363	3,000/Tape & Reel
DMP2900UDW-13	SOT363	10,000/Tape & Reel

Q1 P-CHANNEL

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

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## **Marking Information**

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E	3D2	2	Ŧ	М	
	MY		20	18	

BD2 = Product Type Marking Code

- YM = Date Code Marking
- $\overline{Y}$  = Year (ex: I = 2021)

M = Month (ex: 9 = September)

### Data Codo Kov

Notes:

Date Code Key												
Year	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031
Code	Н	Ι	ſ	K	L	М	Ν	0	Р	R	S	Т
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteris	Symbol	Value	Unit		
Drain-Source Voltage	VDSS	-20	V		
Gate-Source Voltage	Vgss	±6	V		
Continuous Drain Current (Note 6) $V_{GS}$ = -4.5V	lD	-0.63 -0.5	A		
Maximum Continuous Body Diode Forward Current	ls	-0.42	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	b)		Ідм	-2.5	A

## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

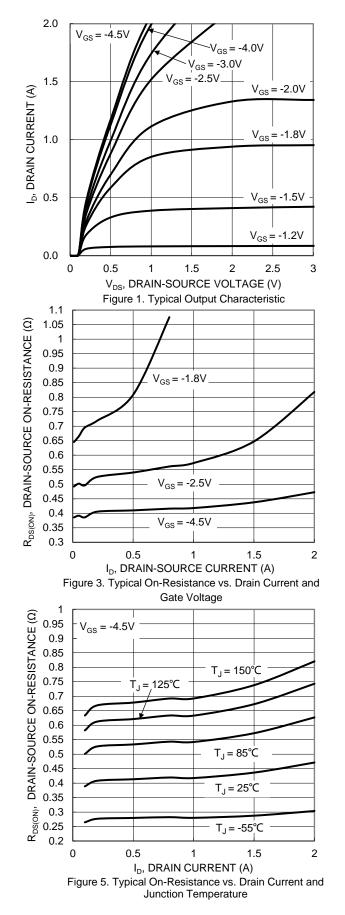
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T <sub>A</sub> = +25°C	PD	0.37	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R <sub>θJA</sub>	340	°C/W
Total Power Dissipation (Note 6)	T <sub>A</sub> = +25°C	PD	0.46	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	272	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

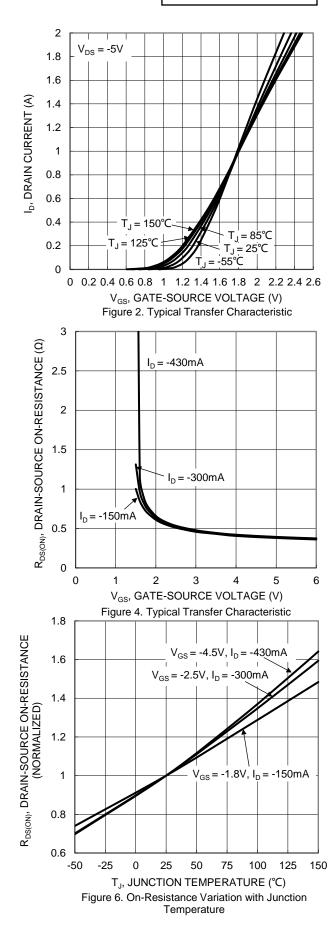
## Electrical Characteristics (T<sub>A</sub> = +25°C, V<sub>BIAS</sub> = 5V, V<sub>IN</sub> = 1.05V, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage		BVDSS	-20		—	V	Vgs = 0V, Id = -250µA
Zero Gate Voltage Drain Current	@Tc = +25°C	IDSS	_	_	-100	nA	$V_{DS} = -20V$ , $V_{GS} = 0V$
Gate-Source Leakage		lgss	_	_	±2.0	μA	$V_{GS} = \pm 4.5 V$ , $V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage		VGS(TH)	-0.5	_	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
				0.4	0.75		Vgs = -4.5V, ID = -430mA
Static Drain-Source On-Resistance		RDS(ON)	_	0.53	1.05	Ω	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -300mA
				0.7	1.5		$V_{GS} = -1.8V, I_D = -150mA$
Diode Forward Voltage (Note 7)		V <sub>SD</sub>	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$
DYNAMIC CHARACTERISTICS (Note 8)					•		
Input Capacitance		Ciss	_	49	_	pF	
Output Capacitance	utput Capacitance		_	12	_	pF	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance		Crss	_	3.4	_	pF	
Total Gate Charge		Qg	_	0.7	_	nC	
Gate-Source Charge		Qgs		0.1	_	nC	VGS = -4.5V, VDS = -10V, D = -250mA
Gate-Drain Charge		Q <sub>gd</sub>	_	0.1	_	nC	$I_{\rm D} = -250 {\rm mA}$
Turn-On Delay Time		t <sub>D(ON)</sub>	_	16	_	ns	
Turn-On Rise Time		t <sub>R</sub>	_	15		ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time		tD(OFF)	_	213	—	ns	R <sub>g</sub> = 10Ω, R <sub>L</sub> = 47Ω ID = -200mA
Turn-Off Fall Time		tF	—	89		ns	
Reverse Recovery Time		trr	_	10.5	—	ns	I <sub>F</sub> = 1A, di/dt = 100A/µs
Reverse Recovery Charge		Q <sub>RR</sub>	_	1.8	_	nC	$\mu = 1A$ , $\mu/\mu = 100A/\mu s$

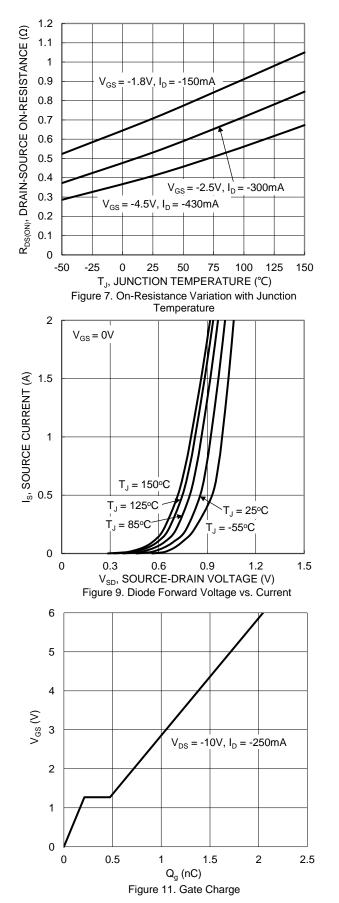
 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing. Notes:

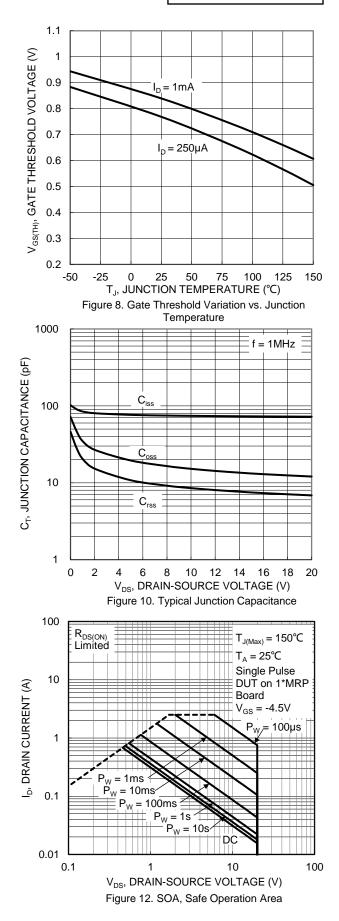




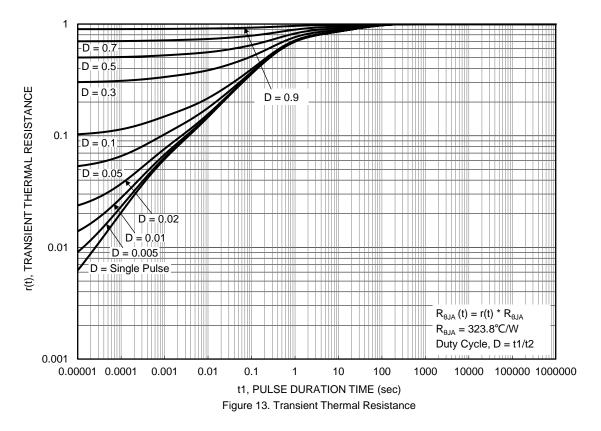








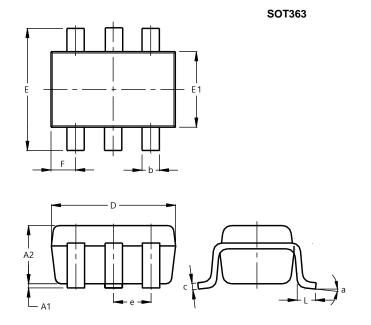






## **Package Outline Dimensions**

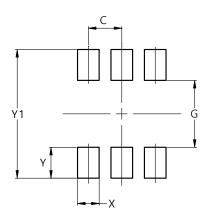
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT363								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
С	0.10	0.22	0.11					
D	1.80	2.20	2.15					
ш	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
e	C	).650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All I	Dimen	sions	in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



# Dimensions Value (in mm) C 0.650 G 1.300 X 0.420 Y 0.600 Y1 2.500

SOT363



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